HGN110N08AL P-1

80V N-Ch Power MOSFET

Feature

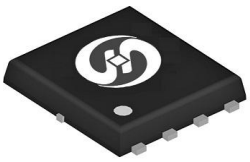
◇ High Speed Power Switching, Logic level
◇ Enhanced Body diode dv/dt capability
◇ Enhanced Avalanche Ruggedness
◇ 100% UIS Tested, 100% Rg Tested
◇ Lead Free, Halogen Free

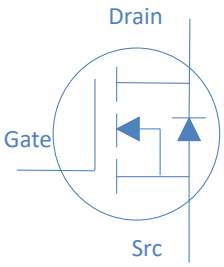
V_{DS}		80	V
$R_{DS(on),typ}$	V_{GS}=10V	9.5	mΩ
$R_{DS(on),typ}$	V_{GS}=4.5V	13.5	mΩ
$I_{D\ (Sillicon\ Limited)}$		48	A
$I_{D\ (Package\ Limited)}$		30	A

Application

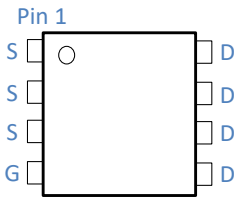
◇ Synchronous Rectification in SMPS
◇ Hard Switching and High Speed Circuit
◇ DC/DC in Telecoms and Inductrial

DFN5*6





Part Number	Package	Marking
HGN110N08AL	DFN5*6	GN110N08AL



Absolute Maximum Ratings at T_j=25℃ (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	I_D	T_C=25℃	48	A
		T_C=100℃	30	
Continuous Drain Current (Package Limited)		T_C=25℃	30	
Drain to Source Voltage	V_{DS}	-	80	V
Gate to Source Voltage	V_{GS}	-	±20	V
Pulsed Drain Current	I_{DM}	-	250	A
Avalanche Energy, Single Pulse	E_{AS}	L=0.4mH, T_C=25℃	45	mJ
Power Dissipation	P_D	T_C=25℃	50	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to150	℃

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	55	℃/W
Thermal Resistance Junction-Case	$R_{\theta JC}$	2.5	℃/W

Electrical Characteristics at T_j=25℃ (unless otherwise specified)

Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=250μA	80	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS}, I_D=250μA	1.0	1.9	2.4	
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS}=0V, V_{DS}=80V, T_j=25℃	-	-	1	μA
		V_{GS}=0V, V_{DS}=80V, T_j=100℃	-	-	100	
Gate to Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V	-	-	±100	nA
Drain to Source on Resistance	$R_{DS(on)}$	V_{GS}=10V, I_D=10A	-	9.5	11.5	mΩ
Drain to Source on Resistance	$R_{DS(on)}$	V_{GS}=4.5V, I_D=5A	-	13.5	16	mΩ
Transconductance	g_{fs}	V_{DS}=5V, I_D=10A	-	30	-	S
Gate Resistance	R_G	V_{GS}=0V, V_{DS} Open, f=1MHz	-	1.3	-	Ω

Dynamic Characteristics

Input Capacitance	C_{iss}	V_{GS}=0V, V_{DS}=40V, f=1MHz	-	1131	-	pF
Output Capacitance	C_{oss}		-	205	-	
Reverse Transfer Capacitance	C_{rss}		-	8.5	-	
Total Gate Charge	Q_g(10V)	V_{DD}=40V, I_D=10A, V_{GS}=10V	-	23	-	nC
Total Gate Charge	Q_g(4.5V)		-	12.5	-	
Gate to Source Charge	Q_{gs}		-	3	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	6	-	
Turn on Delay Time	$t_{d(on)}$	V_{DD}=40V, I_D=10A, V_{GS}=10V, R_G=10Ω,	-	8	-	ns
Rise time	t_r		-	3	-	
Turn off Delay Time	$t_{d(off)}$		-	22	-	
Fall Time	t_f		-	4	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_F=20A	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	V_R=40V, I_F=10A, dI_F/dt=100A/μs	-	35	-	ns
Reverse Recovery Charge	Q_{rr}		-	30	-	nC

Fig 1. Typical Output Characteristics

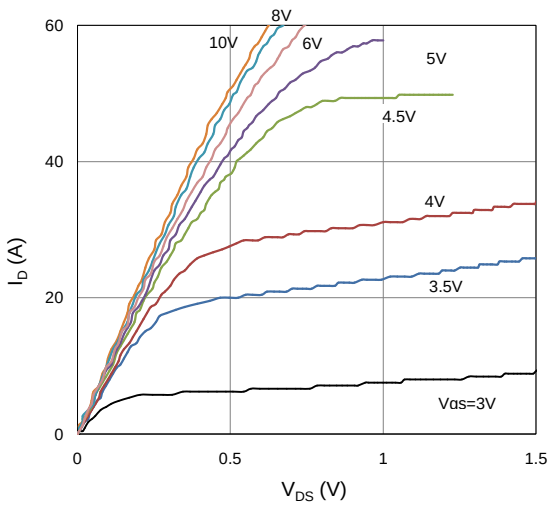


Figure 2. On-Resistance vs. Gate-Source Voltage

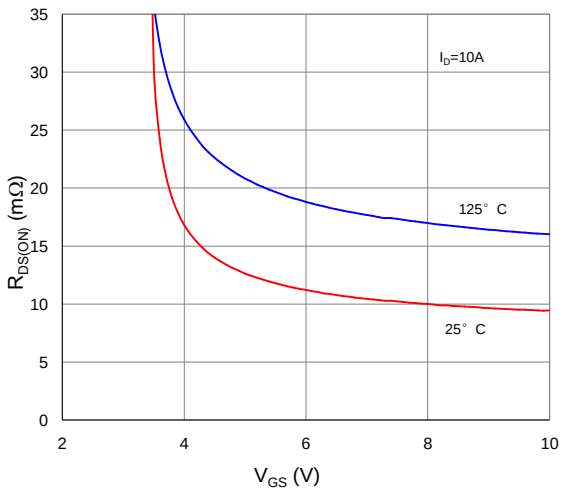


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

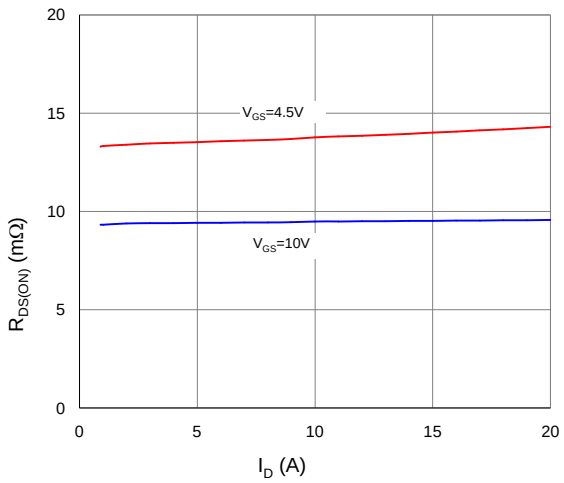


Figure 4. Normalized On-Resistance vs. Junction Temperature

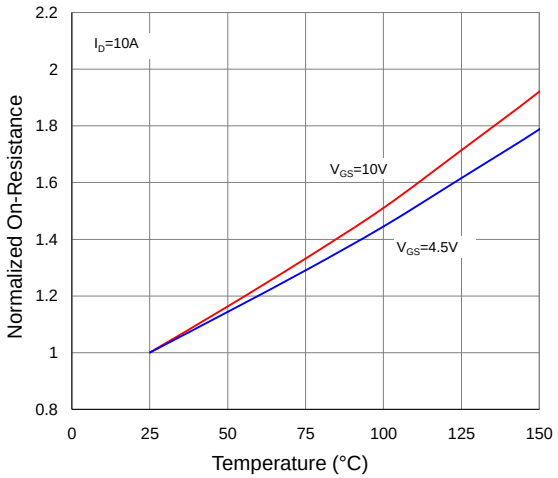


Figure 5. Typical Transfer Characteristics

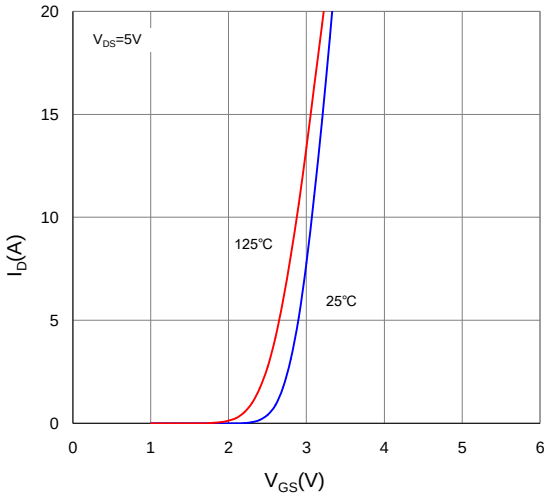


Figure 6. Typical Source-Drain Diode Forward Voltage

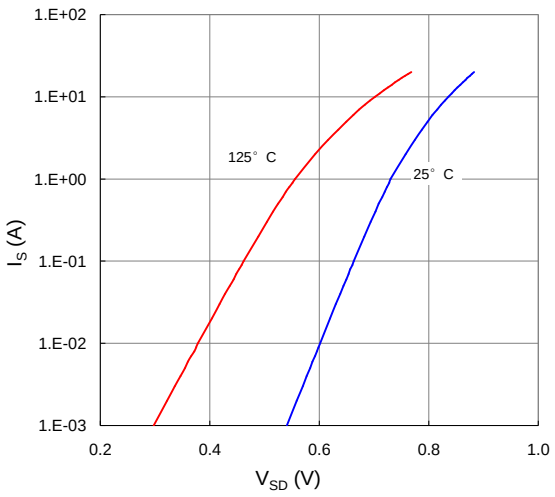


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

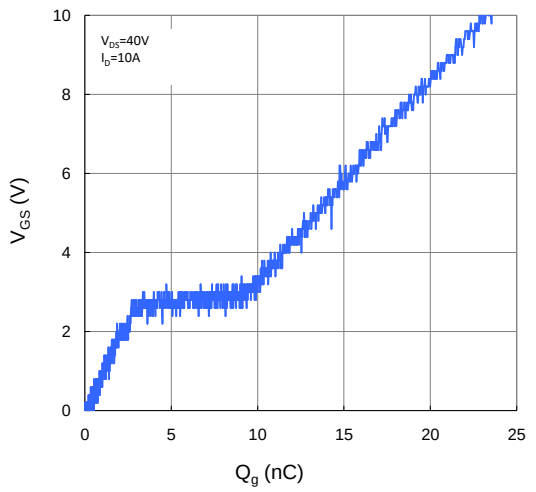


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

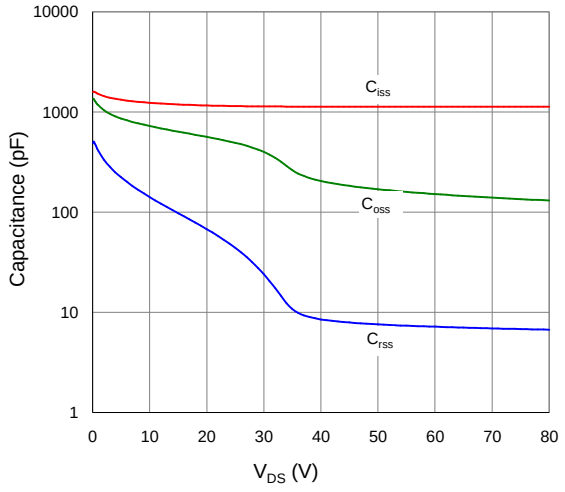


Figure 9. Maximum Safe Operating Area

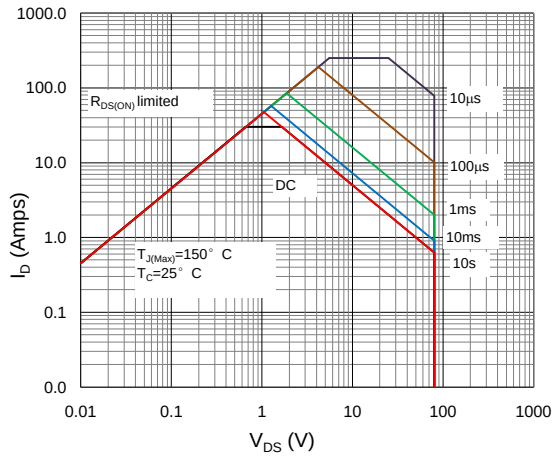


Figure 10. Maximun Drain Current vs. Case Temperature

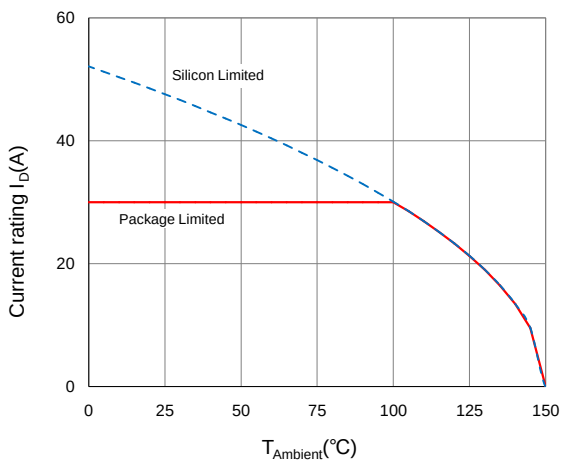
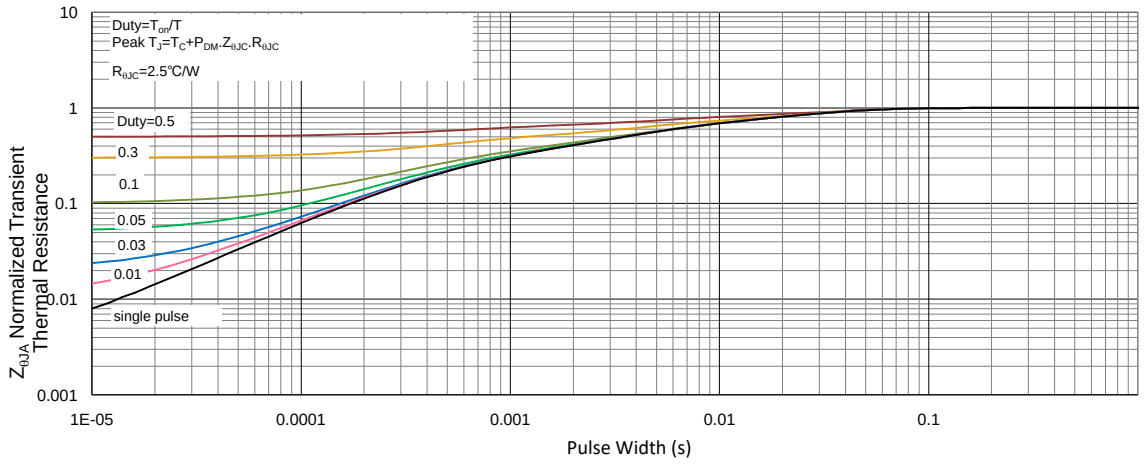
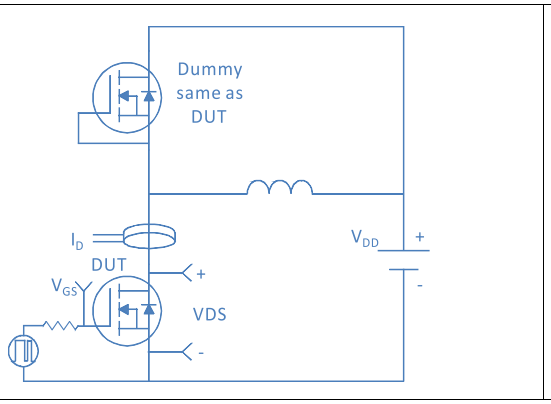
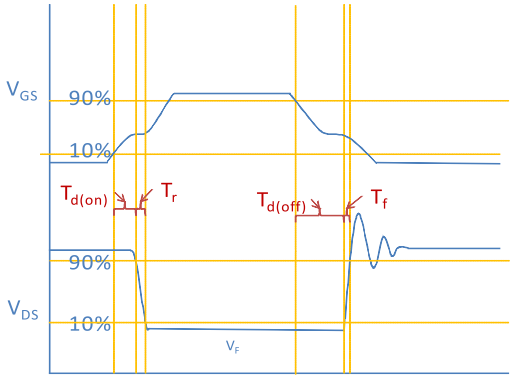


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

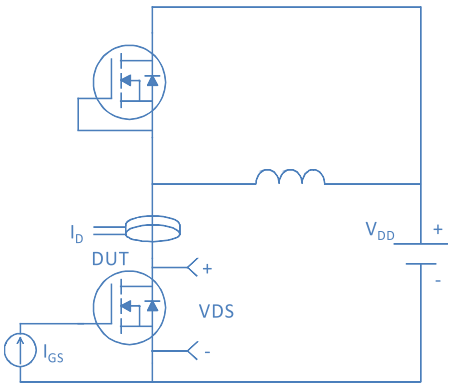


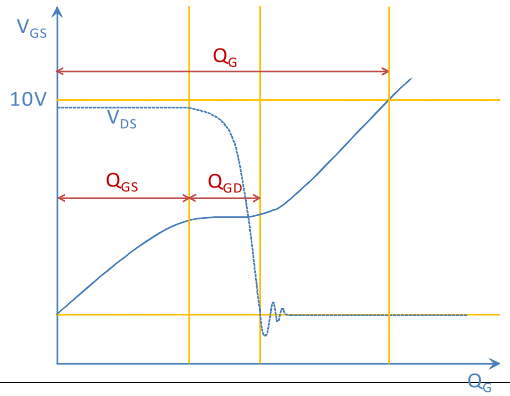
Inductive switching Test



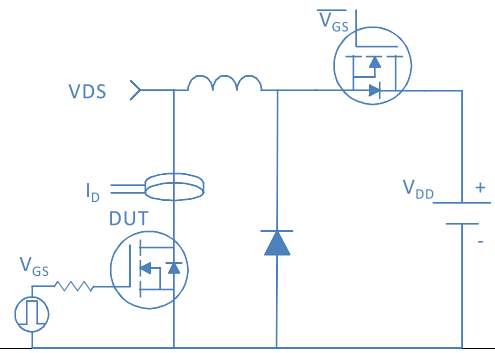


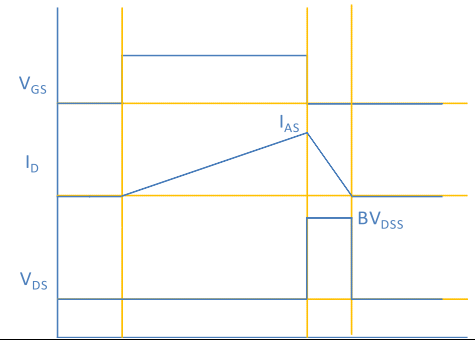
Gate Charge Test



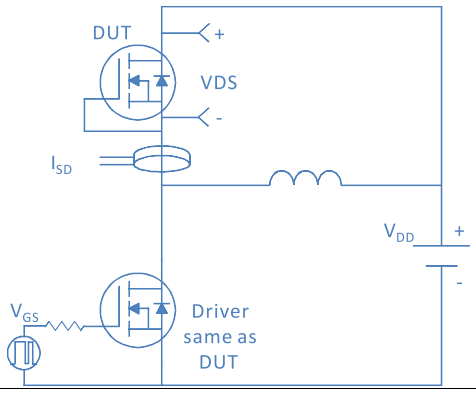


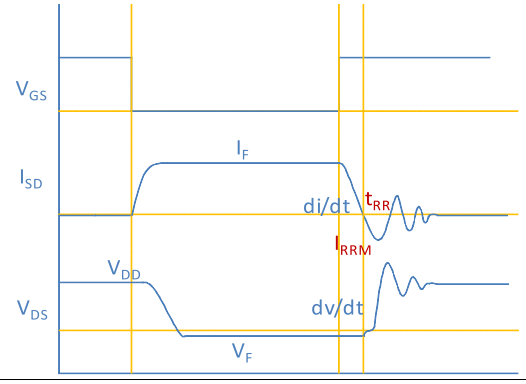
Uclamped Inductive Switching (UIS) Test





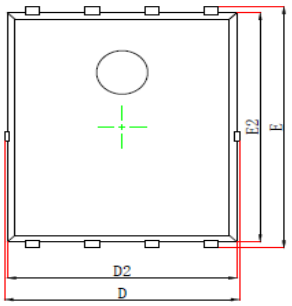
Diode Recovery Test



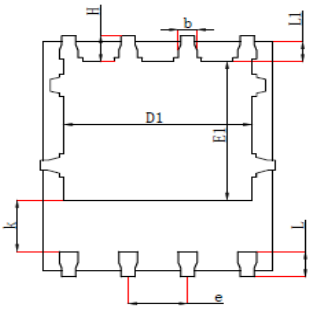


Package Outline

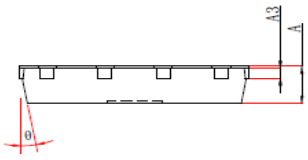
DFN5x6_P, 8 Leads



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A3	0.254 REF		0.010REF	
D	4.680	5.120	0.184	0.202
E	5.900	6.126	0.232	0.241
D1	3.610	4.110	0.142	0.162
E1	3.380	3.780	0.133	0.149
D2	4.800	5.000	0.189	0.197
E2	5.674	5.826	0.223	0.229
k	1.100	1.390	0.043	0.055
b	0.330	0.510	0.013	0.020
e	1.270TYP		1.270TYP	
L	0.510	0.711	0.020	0.028
L1	0.424	0.576	0.017	0.023
H	0.410	0.726	0.016	0.029
θ	0^0	12^0	0^0	12^0